LL030RS1-64P1-OY1 Technical data sheet

Supplier : UIV Chem

Producer: LG Display, Ltd.

Issued date: Jan. 04, 2016

Product : OLED panel

	Development Team	Production Team	QA Team
Approval			
	2016.01.04		

Issue & revision history

Version	Deta	Description
VEISIOII	Date	Description
0	2016/01/04	Issued (Tentative)

Rigid Square Type OLED Panel (LL030RS1-64P1-OY1)

1. Ordering Information

Model	Description	Efficacy	ССТ
LL030RS1-64P1-OY1 Panel with flexible PCB		55lm/W	4000K

2. General Conditions

Parameter	Temperature	Humidity	Remark
Storage condition	0°C~40°C	< 70% RH	
Transport condition	-20°C~60°C	< 85% RH	Not over 170hrs
Operating condition	0°C~40°C	< 70% RH	

3. Maximum Ratings

Parameter	Sym	Unit	Max.	Condition
DC Forward Voltage	V _F	V	7.0	T _A =25°C
DC Forward Current	I _F	mA	100	T _A =25°C

Disclaimer: Device reliability may be affected if product is operated beyond the given conditions for an extended period of time

4. Electrical & Optical Characteristics

Operation @ 20lm

Parameter		unit	Min.	Тур.	Max.
	Forward voltage	V	5.7	6.0	6.3
Electrical data	DC forward current (Current density)	mA (mA/cm²)		60 (2.84mA/cm ²)	
	Power consumption	W	0.34	0.36	0.38
Optical data	CCT (integrated)	К	3750	4000	4250
	CRI	Ra	87	90	
	Duv		-0.005		0.005
	Spatial uniformity*	%	85		
	Efficacy	lm/W	48	55	62
	Flux	lm	17	20	23
Lifetime**	LT70, @2.84mA/cm ²	Hrs.		30000	

^{*} Luminous uniformity calculation formula: $U = [1-(Lmax-Lmin)/(Lmax+Lmin)] \times 100\%$

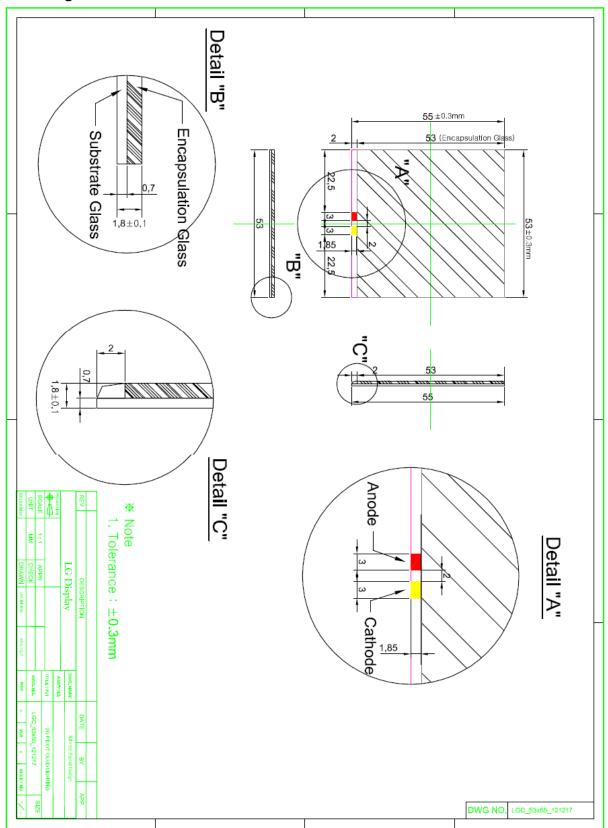
^{**} Operating Lifetime is from the beginning of operation until brightness reaches 70% of the initial luminance. (Assumed Operating Condition: 25 °C at typical brightness level)

5. Mechanical Dimensions

	Parameter	Sym	Unit	Bare panel
	Length	L	mm	53±0.3
	Width	W	mm	55±0.3
Outer	Thickness*	Т	mm	1.97±0.1
	Shape			Square
	Weight		g	<14
lanar	Encapsulation area		mm²	53x53
Inner	Luminance area		mm²	46x46

[·] Thickness with out-coupling film

6. Drawings



7. Appearance Criteria

Items	Criteria			
Dark spot	Defects are judged by the size of each item in the active area and based on the criteria below			
	Size(mm)	Acceptable number		
Particle	D ≤ 0.5	Not counted		
	0.5 < D ≤ 0.8	Not over 5		
Pinhole	0.8 < D	Not allowed		
	Note : D =(a+b)/2			
Dent on surface		a		
Bubble	b	Y		
	Defects are judged by the size of each item in the active area and based on the criteria below			
Scratch or line	Size(mm)	Acceptable number		
on emitting surface	Width ≤0.3	Not counted		
	0.3 < Width or 10 < Length	Not allowed in active area		
	10 \ Longui	in douve area		
Chip	Defects are judged based on the criteria below * Corner chip : Not allowed if a > 2mm or b > 2mm * Edge chip : Not allowed if a > 10mm or b > 2mm or c ≥ t			
	Note : t= Thickness of glass (Substrate or Encapsulation)			

8. Reliability

- Evaluation criteria : Luminance change within +/- 10% of initial value

Items	Condition	
High temperature/humidity operation	60°C, 90% RH / IF=Typ.mA,96Hrs	
Thermal shock	-45°C,15min ↔ 85°C,15min 1cycle ,200cycles	
High temperature /humidity storage	+85°C, 85% / 500Hrs	
Life time	Room Temp. / IF=Typ.mA, 2,000Hrs	

9. Guideline to OLED Handling

A. Handling and Safety

- 1. Unpack packing box with care. Remove packing trays gently and carefully from packing box.
- 2. During unloading and handling, gloves are required to prevent finger cuts or possible shocks. Gloves are also required to avoid fingerprints being left on the glass, and to keep moisture from causing corrosion to the metal traces.
- 3. Handle panels with caution. Mechanical stress such as shocks and pressures on the panel surface (active area, encapsulation glass cavity area) must be avoided to prevent cracking of the glass, delamination, scratching of the film, and internal structure damage. Do not press or drop the panel.
- 4. During unloading and handling, panels should always be held from the side. Avoid direct contact with metal contact pads or connector traces.
- 5. Protect the panel surface from scratches. Avoid direct contact on panel surface and do not stack panels on top of each other.
- 6. Protect the corners and edges during handling, assembly or installation to prevent chipping or breakage of glass.
 - 7. Avoid contact with chemicals such as solvents.
- 8. Contact with water must be avoided to prevent damage of films and corrosion of metal traces. Water drops must be wiped immediately.
- 9. To remove particle/foreign materials and surface stains, gently wipe the surface of the panel with non-abrasive cloth.
 - 10. In case of breakage, avoid direct contact with bare hands. Do not swallow particles, chips, or materials.
- 11. For interconnections, spring contacts are recommended. Soldering and other interconnecting technologies which apply heat to the panel may cause damage, and are therefore not recommended.
 - 12. Do not hold the panel on the surface . Hold the panel from the edge.
- 13. In case of connecting multiple panels, series connection is highly recommended. Panel to panel uniformity problem can occur by parallel connection.

B. Storage and Operation

- 1. Store and operate OLED panels within the ranges specified in the product specifications on page 1. Recommended temperature is at 25°C; Recommended relative humidity is below 60% (RH). (High temperature and humidity can cause film degradation, bubble generation, and film delamination)
 - 2. Store panels as delivered from LG Chem.

C. Disposition

Dispose OLED materials/panels/modules in accordance with each region's environmental laws and regulations. If necessary, consult qualified agencies on industrial waste treatment.

Appendix

A. Soldering guide

1. Please, follow the recommendation as below.

- Max temp: 400°C

- Duration time : up to 2 sec